



# **Dual N-Channel 2.5-V (G-S) MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$r_{DS(on)}(\Omega)$	I <sub>D</sub> (A)		
20	0.075 @ V <sub>GS</sub> = 4.5 V	±4.2		
	0.134 @ V <sub>GS</sub> = 2.5 V	±3.1		

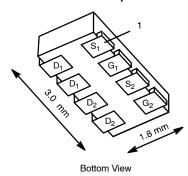
#### **FEATURES**

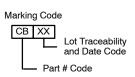


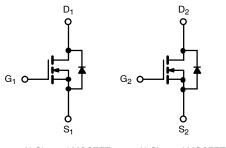
- TrenchFET® Power MOSFET
- 2.5-V Rated
- Lead (Pb)-Free Version is RoHS Compliant

Available









N-Channel MOSFET

N-Channel MOSFET

Si5904DC-T1 Ordering Information:

Si5904DC-T1—E3 (Lead (Pb)-Free)

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)						
Parameter		Symbol	5 secs	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	20		٧	
Gate-Source Voltage		$V_{GS}$	±12			
0 11 0 17 (	T <sub>A</sub> = 25°C	I <sub>D</sub>	±4.2	±3.1		
Continuous Drain Current (T <sub>J</sub> = 150°C) <sup>a</sup>	T <sub>A</sub> = 85°C		±3.0	±2.2		
Pulsed Drain Current		I <sub>DM</sub>	±10		Α	
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	1.8	0.9		
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25°C	Б	2.1	1.1	14/	
	T <sub>A</sub> = 85°C	P <sub>D</sub>	1.1	0.6	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150			
Soldering Recommendations (Peak Temperature) <sup>b, c</sup>				260	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
	t ≤ 5 sec	R <sub>thJA</sub>	50	60	°C/W
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		90	110	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	30	40	

- Surface Mounted on 1" x 1" FR4 Board.

  See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder intercon-
- Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

# **Vishay Siliconix**

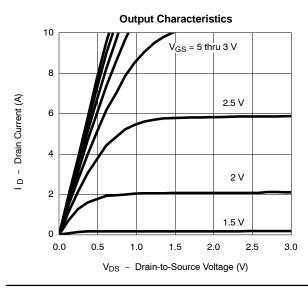


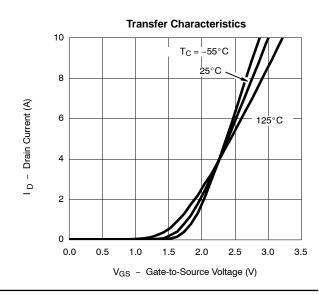
SPECIFICATIONS (T <sub>J</sub> = 25°C UNLESS OTHERWISE NOTED)								
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
Static			•	•		•		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.6		1.5	V		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = $\pm$ 12 V			±100	nA		
Zero Gate Voltage Drain Current	_	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			1			
	DSS	$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, $T_J$ = 85°C			5	μΑ		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	10			Α		
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	$V_{GS} = 4.5 \ V, I_D = 3.1 A$		0.065	0.075	Ω		
Diam-cource on-clate Hesistance		$V_{GS} = 2.5 \text{ V}, I_D = 2.3 \text{ A}$		0.115	0.143			
Forward Transconductancea	9fs	$V_{DS} = 10 \text{ V}, I_D = 3.1 \text{ A}$		8		S		
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>S</sub> = 0.9 A, V <sub>GS</sub> = 0 V		0.8	1.2	V		
Dynamic <sup>b</sup>			•	•		•		
Total Gate Charge	Qg			4	6			
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 10 V, $V_{GS}$ = 4.5 V, $I_D$ = 3.1 A		0.6		nC		
Gate-Drain Charge	Q <sub>gd</sub>			1.3				
Turn-On Delay Time	t <sub>d(on)</sub>			12	18	ns		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_{L}$ = 10 $\Omega$		35	55			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 1 \text{ A, } V_{GEN} = 4.5 \text{ V, } R_G = 6 \Omega$		19	30			
Fall Time	t <sub>f</sub>			9	15			
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	$I_F = 0.9 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		40	80			

- Notes a. Pulse test; pulse width  $\leq 300~\mu s$ , duty cycle  $\leq 2\%$ . b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



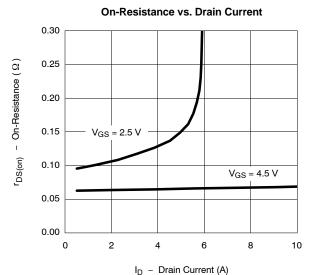




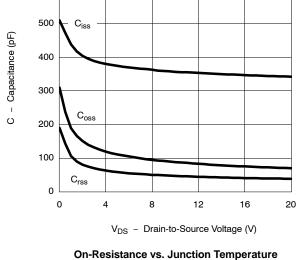




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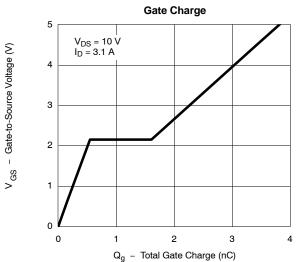




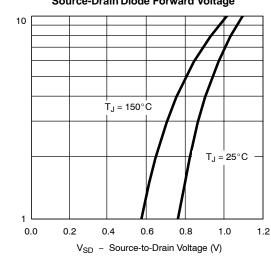


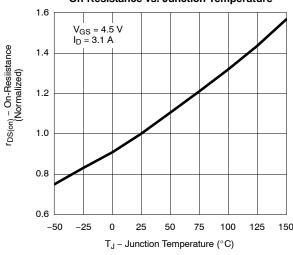
600

Capacitance

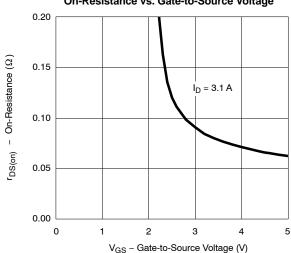


Source-Drain Diode Forward Voltage





On-Resistance vs. Gate-to-Source Voltage

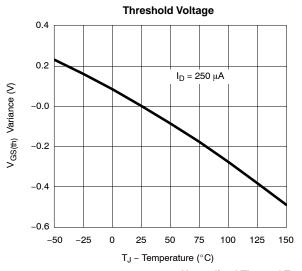


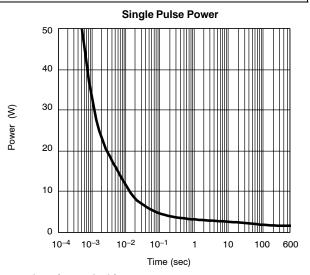
Source Current (A)

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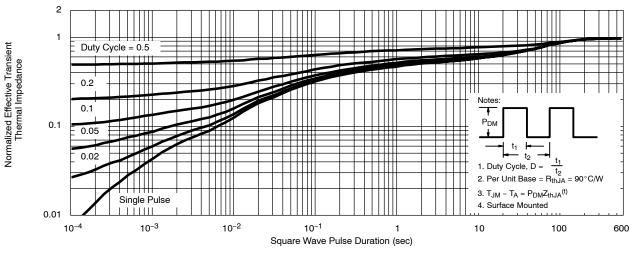


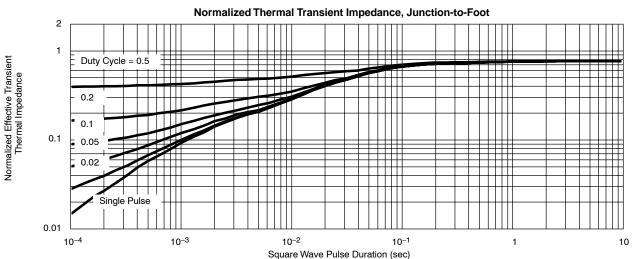
## TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)





#### Normalized Thermal Transient Impedance, Junction-to-Ambient





Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?71065">http://www.vishay.com/ppg?71065</a>.

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